Microtech Technology CO.Ltd.

SAMPLE SPECIFICATIONS

MODULE NO. : MTF0280QT-17 REVISION : V2.0

DRAWING BY : QSC DATE : 2013-04-20

APPROVED BY : DATE :

FOR CUSTOMER'S APPROVAL

CHECK BY: DATE :

APPROVED BY: DATE :

OK ☐ NG ☐

COMMENT：

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History of Versions and Modifications

Version	Modifications	Date
V1.0	Generation first version	Jun16,2011
V2.0	Modify driver IC from HX8347D to ILI9341	Apr 20,2013

CONTENTS

1. Features & Mechanical Specifications

Item	Contents	Unit
	LCD	
LCD Type	TFT Transmissive Normal White	--
Viewing direction	12:00	--
Backlight	White LED x4 in Parallel	--
Interface	RGB interface	--
Driver IC	ILI9341	--
Outline Dimension	50.80(W) × 70.0(H) × 4.00(T)	mm
Active area (W×H)	43.2× 57.60	mm
Number of Dots	240(RGB) × 320	--
Dot pitch (W×H)	0.058*0.058	mm
Pixel pitch (W×H)	0.18 × 0.18	mm
Operating Temperature	-20 ～ +70	℃
Storage temperature	-30 ～ +80	℃

2. Dimensional Outline

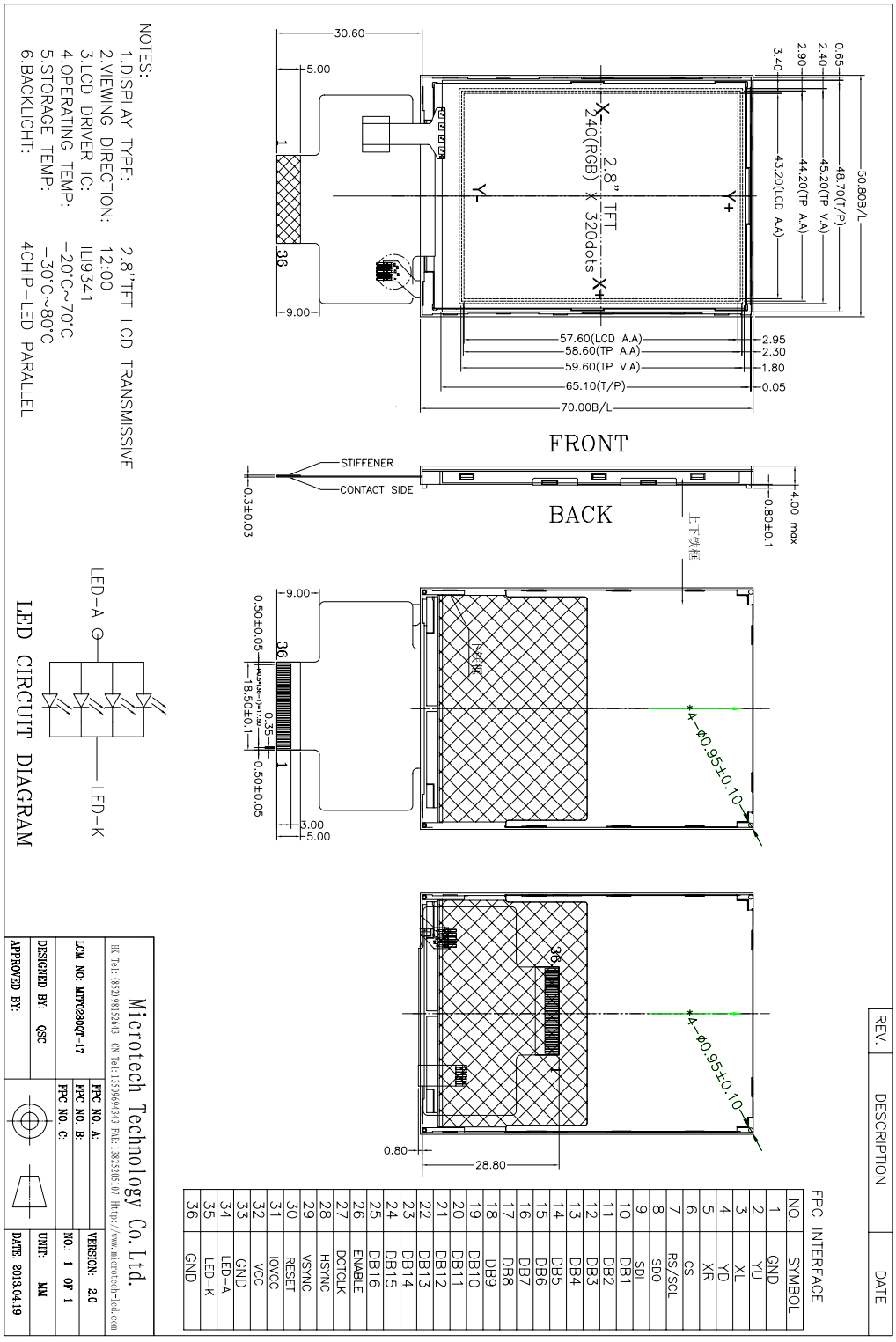


Figure 1. Dimensional outline

3. Block Diagram

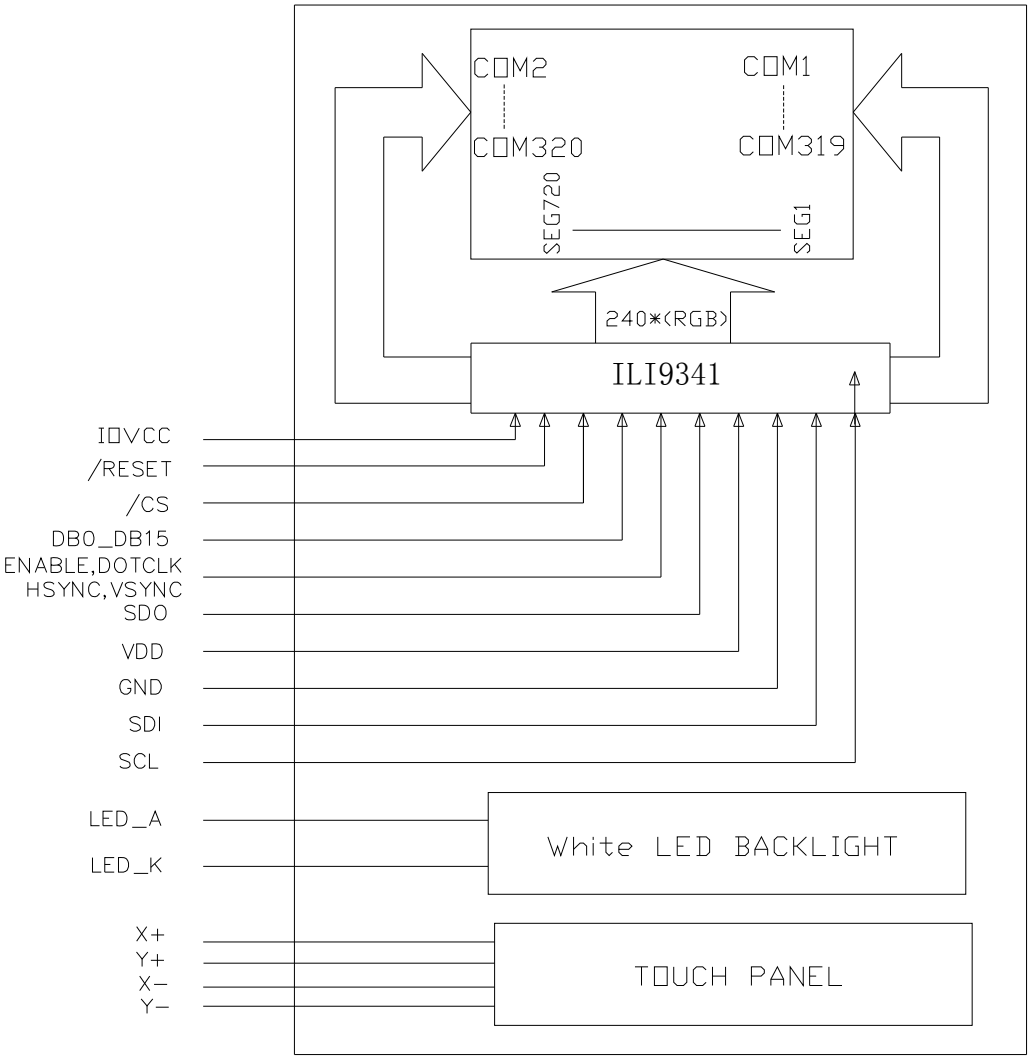


Figure 2. Block diagram

4. Pin Description

PIN No.	SYMBOL	Function
1	GND	System Ground
2	YU	Touch Panel UP
3	XL	Touch Panel LEFT
4	YD	Touch Panel DOWN
5	XR	Touch Panel RIGHT
6	CS	Chip enable,active low
7	SCL	Command/display data select pin
8	SDO	Serial data output
9	SDI	Serial data input
10~25	DB0-DB15	Data bus
26	ENABLE	Date ENEABLE signal for RGB interface operation
27	DOTCLK	Dot clock signal
28	HSYNC	Line synchronizing signal
29	VSYNC	Frame synchronizing signal
30	RESET	Reset Signal pin (“Low” is enable)
31	IOVCC	I/O power supply
32	VCC	Power supply for logic operation
33	GND	System Ground
34	LEDA	Backlight LED Anode.
35	LEDK	Backlight LED Cathode
36	GND	System Ground

5. Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply Voltage range	VDD	-0.3 to +3.3	V
Operating Temperature range	TOP	-20 to +70	℃
Storage Temperature range	TST	-30 to +80	℃

6. Electrical Characteristics

DC Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Logic Supply Voltage	VDD	2.45	-	3.3	V
I/O Supply Voltage	IOVCC	1.65	-	3.3	V

7. Backlight Characteristics

White LED × 4 in parallel **(Ta = 25°C)**

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	VF	IF=60mA	-	3.2	-	V
Uniformity	△Bp	-	80	-	-	%
Luminance for LCD	Lv	IF=60mA		3000-	-	cd/m^2

8. Electro-Optical Characteristics

Using HYDIS LC+ Normal Polarizer+Corresponding Backlight, reference only (Note 1,Note 2)

Item		Symbol	Conditions	Specifications			Unit	Note
				Min.	Typ.	Max.		
Transmittance		T%	Viewing normal angle $\theta_X = \theta_Y = 0°$		4.7		%	All left side data are based on CMO's following condition – Type 767 NTSC: 60% LC:5066 Light : C light (Machine:BM5A) Normal Polarizer Without DBEF
Contrast Ratio		CR		150	250	-	-	
Response Time		T_R		NA	10	20	ms	
		T_F		NA	20	30	ms	
Chromaticity	Red	X_R		0.603	0.633	0.663		
		Y_R		0.299	0.329	0.359		
	Green	X_G		0.264	0.294	0.324		
		Y_G		0.546	0.576	0.606		
	Blue	X_B		0.103	0.133	0.163		
		Y_B		0.092	0.122	0.152		
	White	X_W		0.278	0.308	0.338		
		Y_W		0.316	0.346	0.376		
Viewing Angle	Hor.	θ_{X+}	Center CR≥10		45	-	deg.	
		θ_{X-}			45	-		
	Ver.	θ_{Y+}			35	-		
		θ_{Y-}			15	-		

*Note (1) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

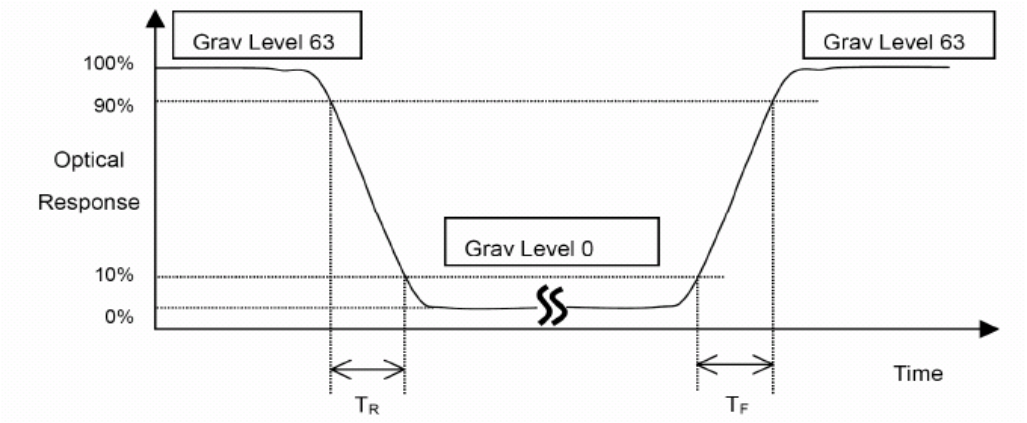
L63: Luminance of gray level 63

L0: Luminance of gray level 0

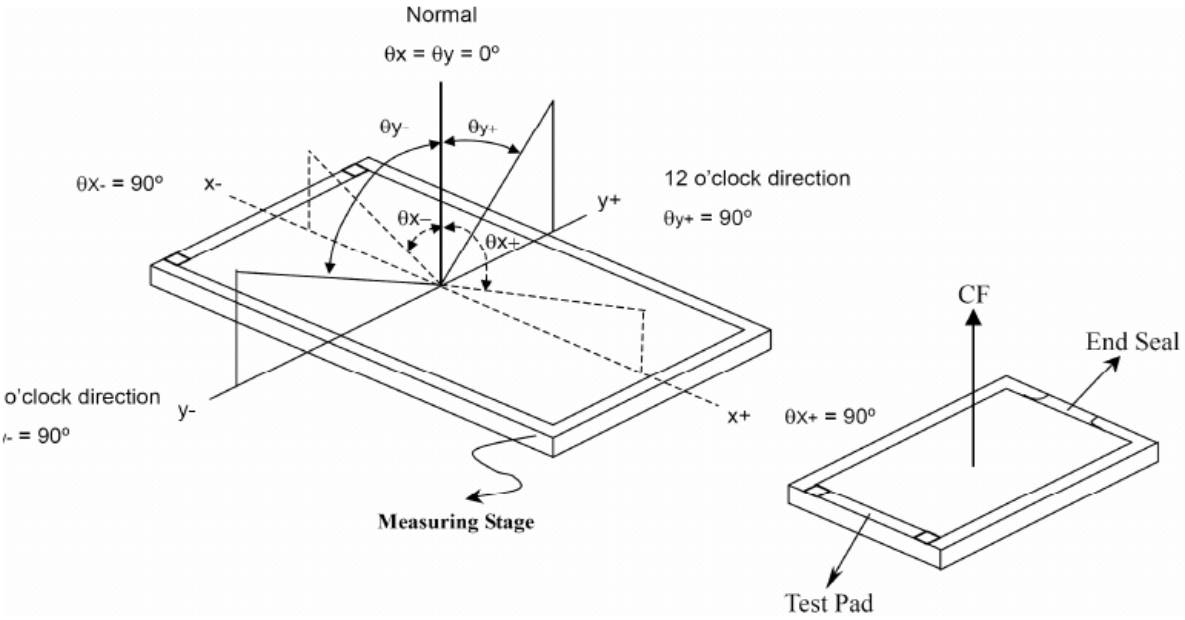
CR = CR (10)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

*Note (2) Definition of Response Time (TR, TF):



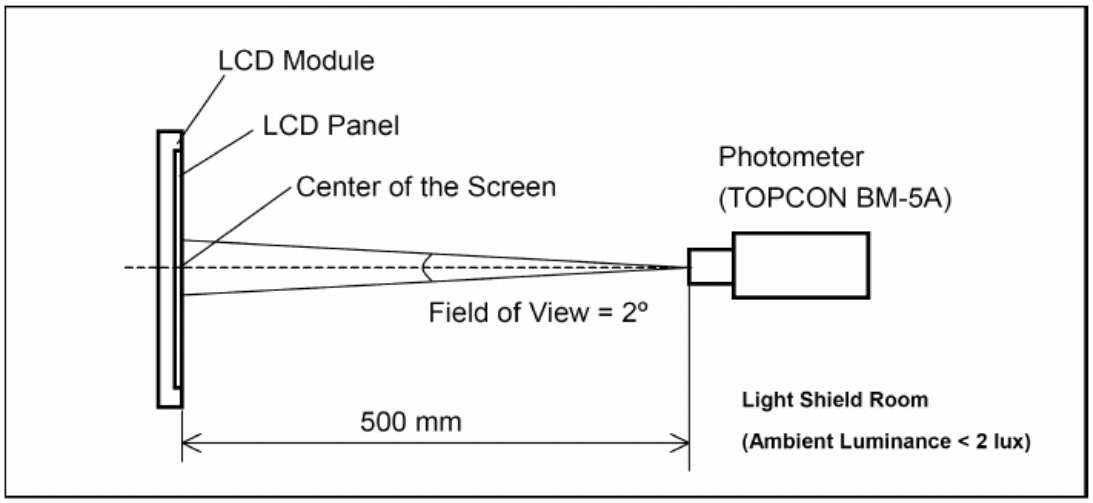
*Note(3) Definition of Viewing Angle



*** The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

*Note (4) Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



10. AC Characteristics

10.1 Serial Interface Characteristics

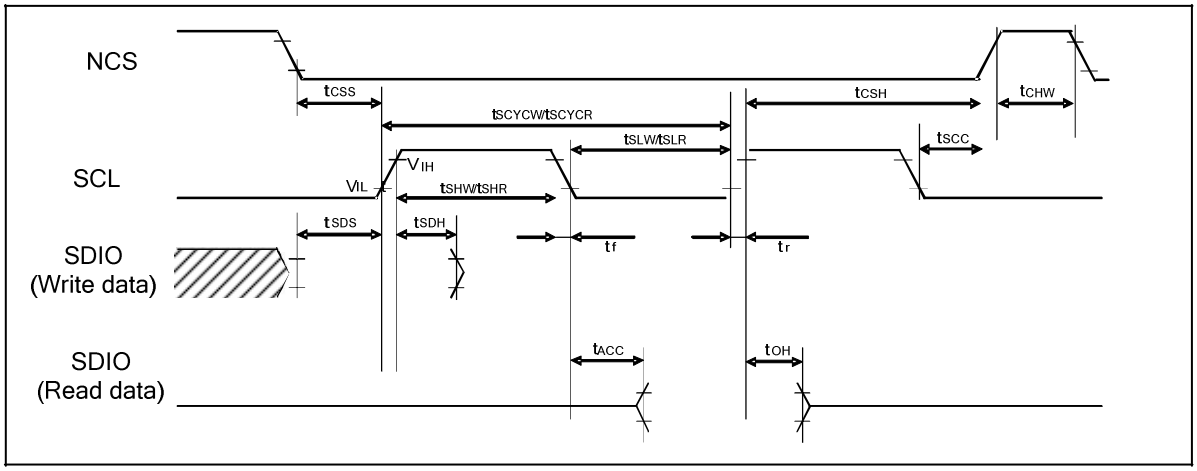


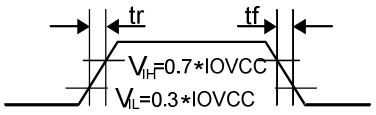
Figure 11.4 Serial interface characteristics

(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.3V to 3.3V, T_A=-30 to 70° C)

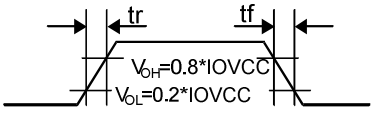
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Serial clock cycle (Write) SCL "H" pulse width (Write) SCL "L" pulse width (Write)	tSCYCW tSHW tSLW	SCL	20 8 8	- - -	- - -	ns
Data setup time (Write) Data hold time (Write)	tSDS tSDH	SDIO	10 10	- -	- -	ns
Serial clock cycle (Read) SCL "H" pulse width (Read) SCL "L" pulse width (Read)	tSCYCR		 60 60	- - -	- - -	ns
Access Time	tACC	SDI for maximum CL=30pF For minimum CL=8pF	10	-	50	ns
Output disable time	tOH	SDO For maximum CL=30pF For minimum CL=8pF	15	-	50	ns
SCL to Chip select	tSCC	SCL, NCS	20	-	-	ns
NCS "H" pulse width	tCHW	NCS	40	-	-	ns
Chip select setup time Chip select hold time	tCSS tCSH	NCS	15 15	- -	- -	ns

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.
Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

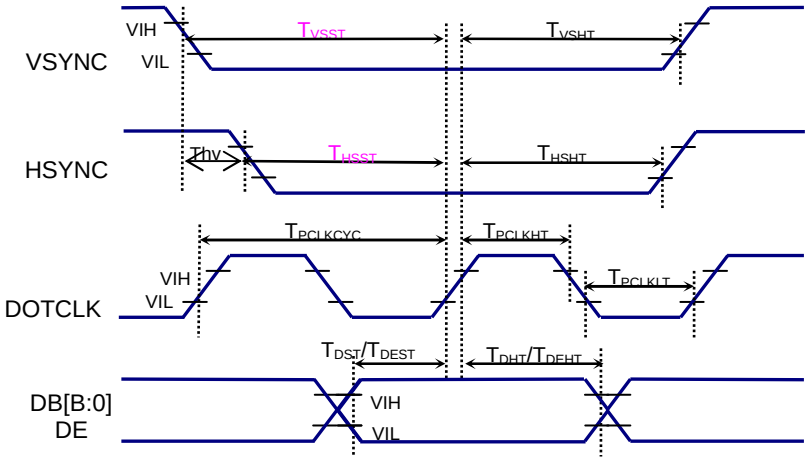
Input Signal Slope



Output Signal Slope



10.2 RGB interface characteristics

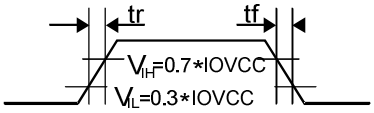


(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.3V to 3.3V,Ta = -30 to 70° C)

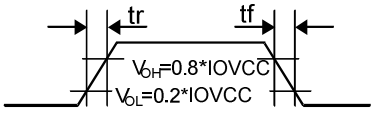
Item	Symbol	Condition	Spec.			Unit
			Min.	Typ.	Max.	
Pixel low pulse width	T_{CLKLT}	-	15	-	-	ns
Pixel high pulse width	T_{CLKHT}	-	15	-	-	ns
Vertical Sync. set-up time	T_{VSST}	-	15	-	-	ns
Vertical Sync. hold time	T_{VSSHT}	-	15	-	-	ns
Horizontal Sync. set-up time	T_{HSST}	-	15	-	-	ns
Horizontal Sync. hold time	T_{VSSHT}	-	15	-	-	ns
Data Enable set-up time	T_{DEST}	-	15	-	-	ns
Data Enable hold time	T_{DEHT}	-	15	-	-	ns
Data set-up time	T_{DST}	-	15	-	-	ns
Data hold time	T_{DHT}	-	15	-	-	ns
Phase difference of falling edge	Thv	-	0	-	240	Dotclk

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.

Input Signal Slope



Output Signal Slope



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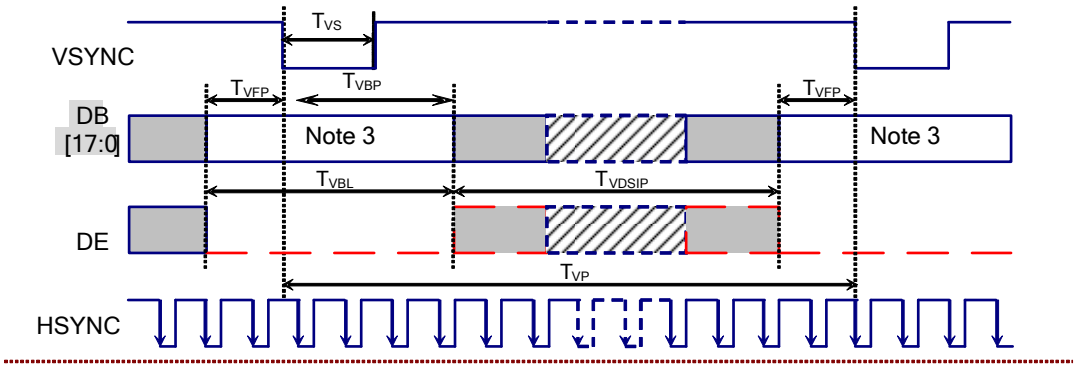
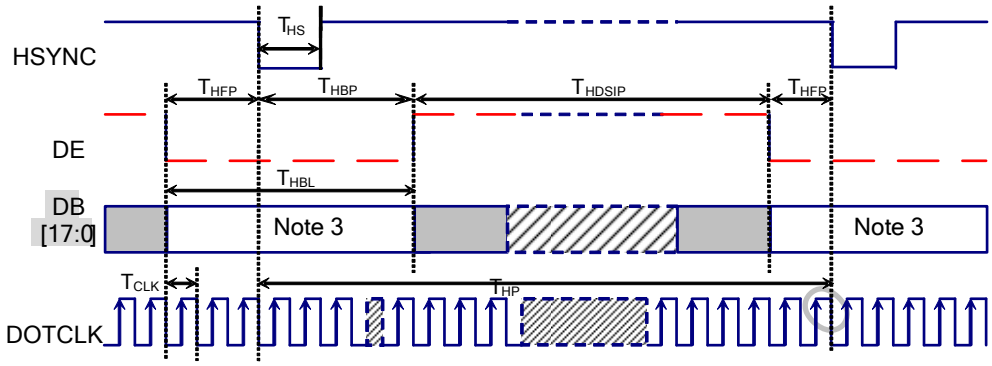
Vertical Timing for RGB I/F



Horizontal Timing for RGB I/F



Item	Symbol	Condition	Spec.			Unit
			Min.	Typ.	Max.	
Vertical Timing						
Vertical cycle period	T_{VP}	-	324	326	452	HS
Vertical low pulse width	T_{VS}	-	2	2	-	HS
Vertical front porch	T_{VFP}	-	2	2	6	HS
Vertical back porch	T_{VBP}	-	2	4	126	HS
Vertical blanking period	T_{VBL}	$T_{VBP} + T_{VFP}$	4	6	132	HS
Vertical active area	T_{VDISP}	-	-	320	-	HS
			-		-	HS
			-		-	HS
Vertical refresh rate	TVRR	Frame rate	50	60	80	Hz
Horizontal Timing						
Horizontal cycle period	T_{HP}	-	244	252	1008	DOTCLK
Horizontal low pulse width	T_{HS}	-	2	2	256	DOTCLK
Horizontal front porch	T_{HFP}	-	2	4	256	DOTCLK
Horizontal back porch	T_{HBP}	-	2	8	256	DOTCLK
Horizontal blanking period	T_{HBL}	$T_{HBP} + T_{HFP}$	4	12	256	DOTCLK
Horizontal active area	T_{HDISP}	-	-	240	-	DOTCLK
Pixel clock cycle TVRR=60Hz	f_{CLKCYC}	-	3.9	-	16.6	MHz

Note: (1) IOVCC=1.65 to 3.3V, VCI=2.3 to 3.3V, VSSA=VSSD=0V, T_A=-30 to 70℃ (to +85℃ no damage)
(2) Data lines can be set to "High" or "Low" during blanking time – Don't care.
(3) HP is multiples of DOTCLK.

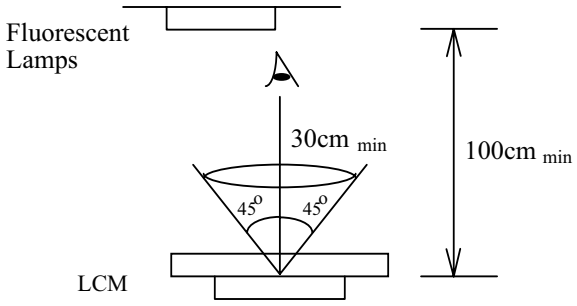
11.Quality Specifications

All The raw material are Rohs complicant.

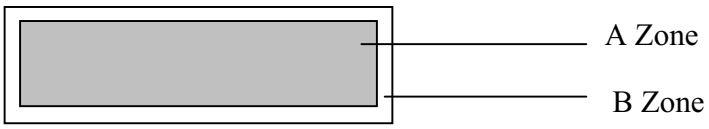
11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area
B Zone: outside viewing area

11.2 Specification of quality assurance

AQL inspection standard

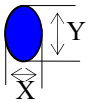
Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

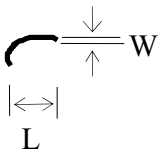
Classify	Item		Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Note on defect classification

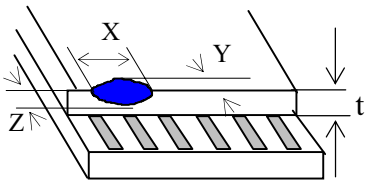
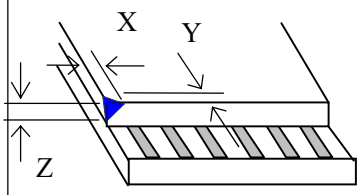
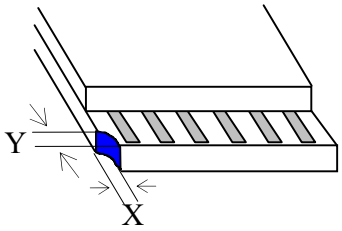
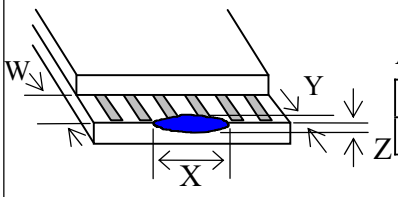
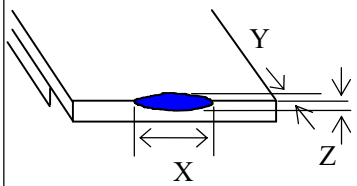
<table>
<tr><th>No.</th><th>Item</th><th>Criterion</th></tr>
<tr><td rowspan="6">1</td><td>Short or open circuit</td><td rowspan="6">Not allow</td></tr>
<tr><td>LC leakage</td></tr>
<tr><td>Flickering</td></tr>
<tr><td>No display</td></tr>
<tr><td>Wrong viewing direction</td></tr>
<tr><td>Wrong Back-light</td></tr>
<tr><td rowspan="2">2</td><td>Contrast defect</td><td rowspan="2">Refer to approval sample</td></tr>
<tr><td>Background color deviation</td></tr>
<tr><td>3</td><td>Point defect,
Black spot, dust
(including Polarizer)

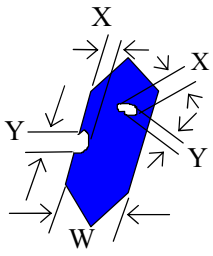
ϕ = (X+Y)/2</td><td> 

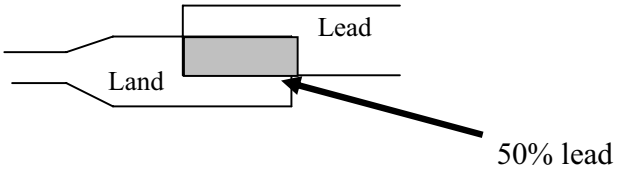
<table>
<tr><th>Point
Size</th><th>Acceptable Qty.</th></tr>
<tr><td>ϕ≤0.10</td><td>Disregard</td></tr>
<tr><td>0.10<ϕ≤0.15</td><td>2</td></tr>
<tr><td>0.15<ϕ≤0.20</td><td>2</td></tr>
<tr><td>ϕ>0.20</td><td>0</td></tr>
</table>
Unit：mm</td></tr>
<tr><td>4</td><td>Line defect,

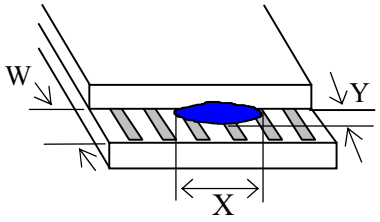
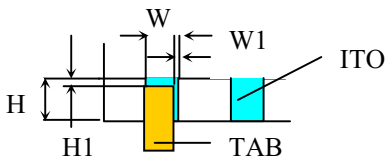
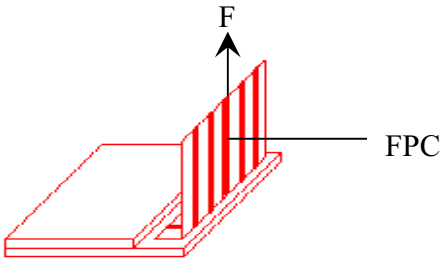
Scratch</td><td> 

<table>
<tr><th colspan="2">Line</th><th>Acceptable Qty.</th></tr>
<tr><td>L</td><td>W</td><td></td></tr>
<tr><td>---</td><td>0.015≥W</td><td>Disregard</td></tr>
<tr><td>3.0≥L</td><td>0.03≥W</td><td rowspan="2">2</td></tr>
<tr><td>2.0≥L</td><td>0.05≥W</td></tr>
<tr><td>1.0≥L</td><td>0.1＞W</td><td>1</td></tr>
<tr><td>---</td><td>0.05<W</td><td>Applied as point defect</td></tr>
</table>
Unit: mm</td></tr>
<tr><td>5</td><td>Rainbow</td><td>Not more than two color changes across the viewing area.</td></tr>
</table>

No	Item	Criterion
6	Chip Remark: X: Length direction Y: Short direction Z: Thickness direction t: Glass thickness W: Terminal Width	 Acceptable criterion X: ≤2 ; Y: 0.5mm ; Z: ≤t/2  Acceptable criterion X: ≤2 ; Y: 0.5mm ; Z: ≤t  Acceptable criterion X: ≤3 ; Y: ≤2 ; Z: ≤t shall not reach to ITO  Acceptable criterion X: Disregard ; Y: ≤0.2 ; Z: ≤t  Acceptable criterion X: ≤5 ; Y: ≤2 ; Z: ≤t/3

<table>
<tr><th>No.</th><th>Item</th><th>Criterion</th></tr>
<tr><td>7</td><td>Segment
pattern
W = Segment width
ϕ = (X+Y)/2</td><td>(1) Pin hole
ϕ < 0.10mm is acceptable.
 

<table><tr><th>Point Size</th><th>Acceptable Qty</th></tr><tr><td>ϕ≤1/4W</td><td>Disregard</td></tr><tr><td>1/4W< ϕ≤1/2W</td><td>1</td></tr><tr><td>ϕ>1/2W</td><td>0</td></tr></table>Unit: mm</td></tr>
<tr><td>8</td><td>Back-light</td><td>(1) The color of backlight should correspond its specification.
(2) Not allow flickering</td></tr>
<tr><td>9</td><td>Soldering</td><td>(1) Not allow heavy dirty and solder ball on PCB.
(The size of dirty refer to point and dust defect)
(2) Over 50% of lead should be soldered on Land.
 
</td></tr>
<tr><td>10</td><td>Wire</td><td>(1) Copper wire should not be rusted
(2) Not allow crack on copper wire connection.
(3) Not allow reversing the position of the flat cable.
(4) Not allow exposed copper wire inside the flat cable.</td></tr>
<tr><td>11*</td><td>PCB</td><td>(1) Not allow screw rust or damage.
(2) Not allow missing or wrong putting of component.</td></tr>
</table>

No	Item	Criterion
12	Protruded W: Terminal Width	 Acceptable criteria: Y ≤ 0.4
13	TAB	1. Position  W1≤1/3W H1≤1/3H 2 FPC bonding strength test  P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer’s end product.

11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	No abnormalities in functions and appearance
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	
Low temp. Operating	-20°C	48	
Humidity	60°C/ 90%RH	48	
Temp. Cycle	-30°C ← 25°C →80°C (60 min ← 5 min → 60min)	10cycles	

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (20±8°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
3. Do not tamper in any way with the tabs on the metal frame.
4. Do not made any modification on the PCB without consulting MTC
5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
5. Only properly grounded soldering irons should be used.
6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
7. The normal static prevention measures should be observed for work clothes and working benches.
8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

1. Soldering should be performed only on the I/O terminals.
2. Use soldering irons with proper grounding and no leakage.
3. Soldering temperature: 280°C±10°C
4. Soldering time: 3 to 4 second.
5. Use eutectic solder with resin flux filling.
6. If flux is used, the LCD surface should be protected to avoid spattering flux.
7. Flux residue should be removed.

Operation Precautions:

1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
4. Response time increases with decrease in temperature.
5. Display color may be affected at temperatures above its operational range.
6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

MTC LCDs and modules are not consumer products, but may be incorporated by MTC's customers into consumer products or components thereof, MTC does not warrant that its LCDs and components are fit for any such particular purpose.

1. The liability of MTC is limited to repair or replacement on the terms set forth below. MTC will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between MTC and the customer, MTC will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with MTC general LCD inspection standard. (Copies available on request)
2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.